

S.A.B.R.E Commercial Smart Breaker

Group 23



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Motivation and Background



- Conventional Circuit breakers used in the United States continue to rely primarily on thermal-magnetic trip mechanisms, a design that has been in widespread use for several decades. Although incremental improvements in materials, safety standards, and protective features have been implemented, these devices still depend on mechanical components that can degrade over time with repeated operation and fault interruptions.
- Our team was tasked by Dr. Qun Zhou Sun from the University of Central Florida and Grid Interactive Things Inc. to innovate the design of the conventional breaker to keep up with modern standards.



Motivation and Background

- In its current design the conventional breaker lacks:
 - **real time monitoring and data logging**, allowing real, up-to-date analysis of the building's power usage and warnings of energy spikes that could lead to trips in the future.
 - **Remote management** to protect the building from hazards that may occur while away
 - **Limited Diagnostic Capability** and predictive maintenance support monitoring the integrity of the system for possible damage over time.
 - The conventional breaker also has a **failure rate** of roughly **0.83%** as reported in a reliability study by the U.S. Army Corps of Engineer Power Reliability Enhancement Program.



Goals and Objectives

Basic Goals

- Build a Smart Circuit Breaker capable of **protecting against overcurrent, short circuits, conditions** being able to meet standard electrical safety code (NEC/UL/IEEE/NEMA) on a reduced scale.
- Create a **built-in communication system** allowing for remote controlled access via a website to allow for real-time monitoring, remote control operation, and predictive maintenance insights through a user-friendly interface.
- Provide **predictive fault detection** analysis to inform the user of irregularities during power consumption of a house allowing them to respond accordingly if not automatically.
- **Minimize power consumption** of device.



Goals and Objectives

Advanced Goals

- Integrate Sensors able to send data through to communication systems with minimal error with quick response time to website.
- Incorporate components capable of withstanding surges to prevent replacements and repairs at later times.
- Implement temperature monitoring to warn users of potential heat surges or fires within the system..
- Create an user-friendly, easy to install system where one can easily pick up and place the entire system into their breaker box.



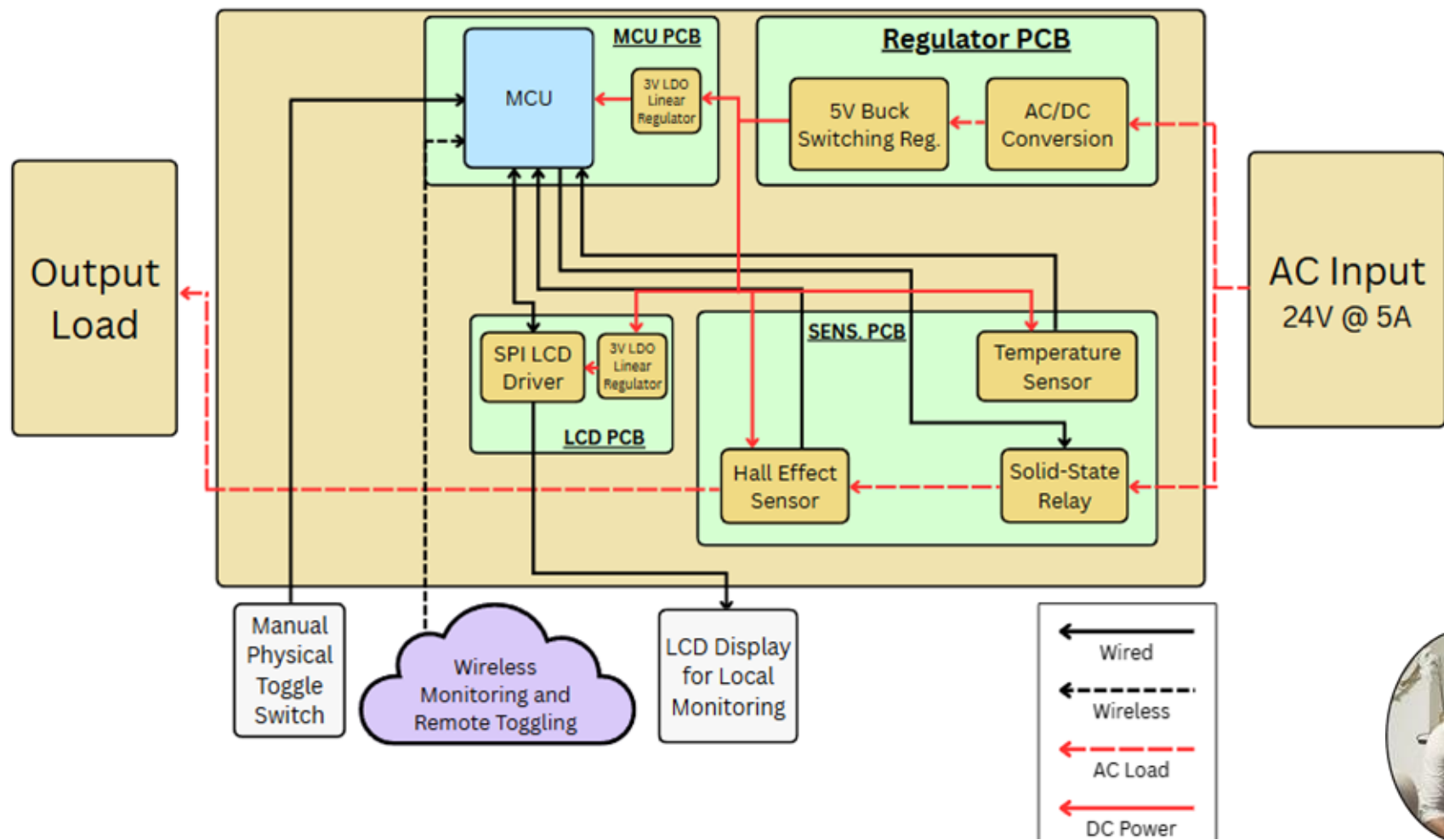
Specifications

Overall System Specifications		
Specification	Target Value	Tolerance
Operating Voltage	24 VAC (single phase)	±10%
Rated Current Capacity	5 A	±5%
Trip Response Time (short)	< 5ms	IEEE Standard
Interrupt Rating	500 AIC	Scaled Down Proportional to the UL 489 Standard
Continuous Load Rating	80% of rated value	±5%
Comm. Range	≥ 15 m (indoor)	N/A
Operating Temperature Range	-10 °C to 60 °C	IEC 60068 Standard
Power Consumption (electronics)	< 10 W	±10%
Dimensions (HxWxD)	≤ 120 × 25 × 70 mm	Stand. Size - 0 tolerance

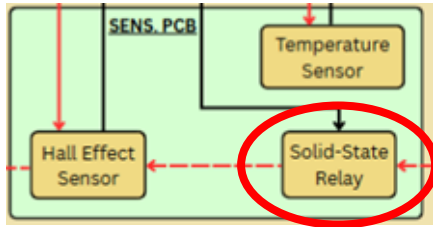


Hardware Block Diagram





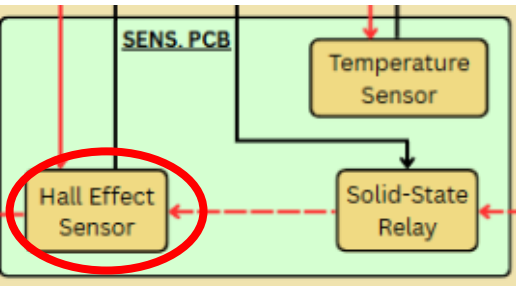
Hardware Selection



Primary Gate Component Selection			
Metrics	Mechanical Relay	Solid-State Relay	MOSFET Configuration
Avg Switching Speed	10ms	1ms	1 μ s
Switching Element	Metal Contacts actuated by electromagnetic coil	Triacs, Thyristors, MOSFETS	MOSFET Channel
Isolation	High- Physical gap between coil and contacts	Medium - Optical Isolation	Low - No inherent isolation
Avg. Durability	10^5 operation	10^9+ operations	10^9+ operations
Leakage Current	Extremely low, pA range	Low: μ A range	Low: μ A range
Form Factor	Bulky: Coil contacts, housing	Very Compact: SMD	Very Compact: SMD
Avg. Cost	\$5.00	\$25.00	\$2.00



Hardware Selection

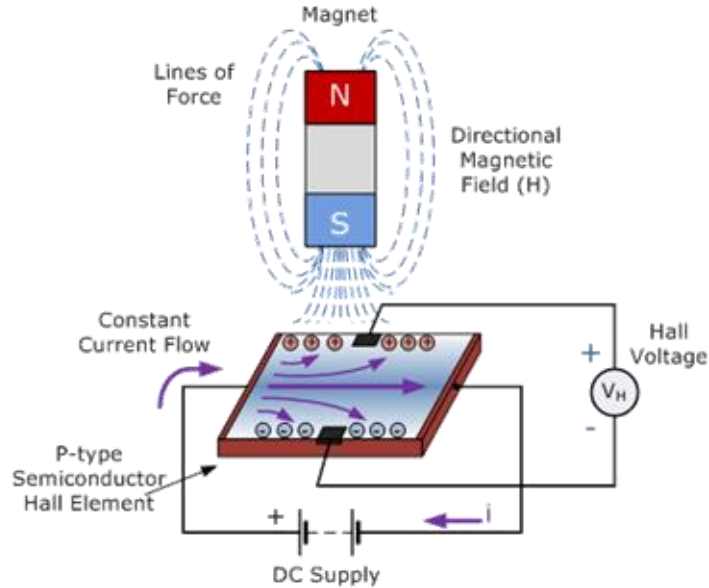


Current Measuring Methodologies		
Metrics	Current Transformer with Shunt Resistor	Hall-Effect Sensor
Accuracy	High	Good
Detection Method	KCL	Magnetic Field Detection
Form Factor	Relatively Large for our desired PCB size	Very Compact: SMD
Power Loss?	Minimal	Minimal
Cost	≈ \$20.00	≈ \$12.00



Hardware Selection

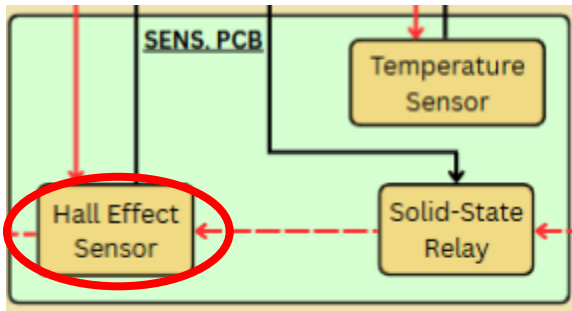
Hall Effect Sensor (ACS712-30A)



$$V_H = \frac{BI}{qnt}$$

- Electric Current produces magnetic field causing hall voltage to be applied
- Standalone component

Current Range	30 A
Input Supply Voltage	5 V DC
Form Factor	Integrated Circuit
Mounting Method	SMD
Output Resolution	66 mV/A
Cost	\$12.00



Hardware Selection

Voltage Step-Down Methodologies			
Metrics	AC Transformer	Linear Regulator	Buck Regulator
Efficiency	Best	Poor	Good
Heat Dissipation	Best	Poor	Best
Isolation	Best	Poor	Good
Avg. Size	Poor	Best	Good
Avg. Cost	Good	Good	Good

Regulator PCB

5V Buck
Switching Reg

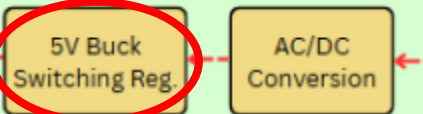
AC/DC
Conversion

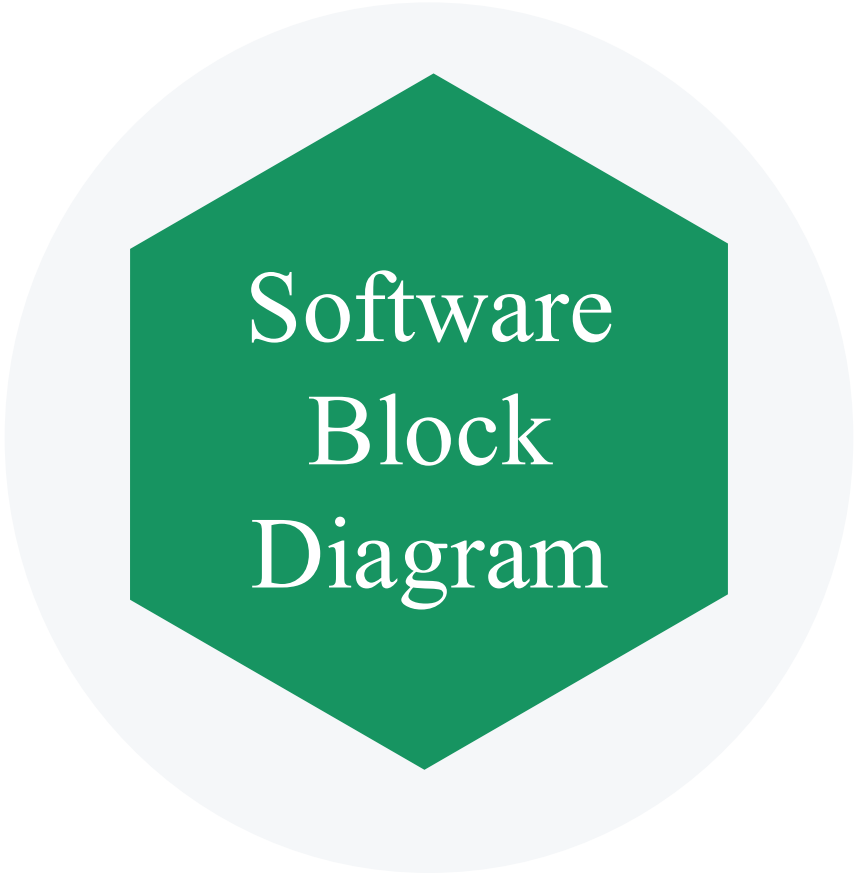


Hardware Selection

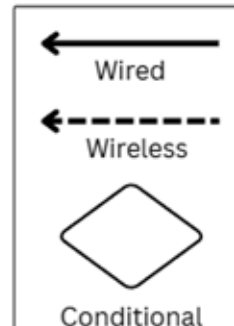
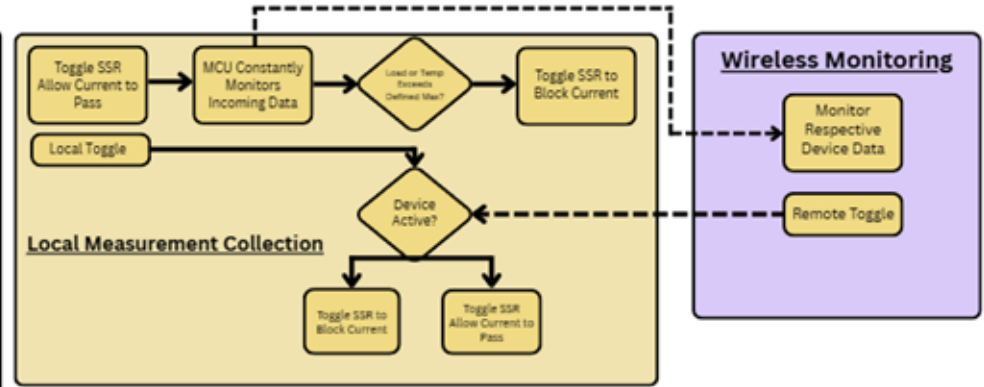
Buck Regulator Selection				
Metrics	LM5180	LM2576HV	LM5160DNT	LMR71915F-DDA
Avg. Cost	\$4.50	\$3.50	\$5.00	\$2.82
Efficiency	88%	88%	85%	90%
Size	4mm x 4mm	10.2 mm x 15.2 mm	4mm x 4mm	SMD only
Max Power Capability	7 W	45 W	130 W	172.5 W
Max Input Voltage	65 V	60 V	65 V	115 V
Max Supply Current	1.5 A	3 A	2 A	1.5 A

Regulator PCB



The logo consists of a dark green hexagon centered within a light gray circle. The hexagon contains the text "Software Block Diagram" in white, serif font, arranged in three lines.

Software Block Diagram



Measuring Alternating Current

Measuring DC signal with HE sensor is trivial. With an AC signal however, there are some things to take into account.

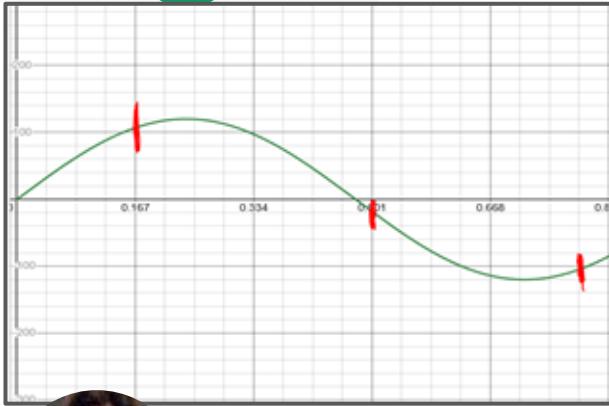
The change in the AC signal will affect the proportional analog voltage signal depending on where the measurement takes place in the sin wave.

To account for this, samples are taken along a given window that corresponds to a number of full cycles.

According to the Nyquist rule, sampling must be at least twice that of the incoming signal to capture meaningful data. For a 60Hz signal, would need at least 12 $f_s > 2 \cdot f_{signal}$

Take N number of samples over a single cycle. Square each individual value and sum them together. Square root the mean of these samples to produce RMS voltage
$$\sqrt{\frac{1}{N} \cdot \sum_{n=1}^N V_N^2}$$

Calculate RMS current by using the conversion specified by the sensor in the datasheet.

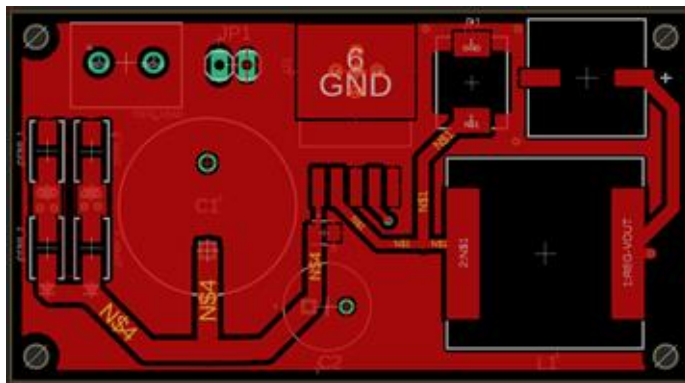


MCU Selection

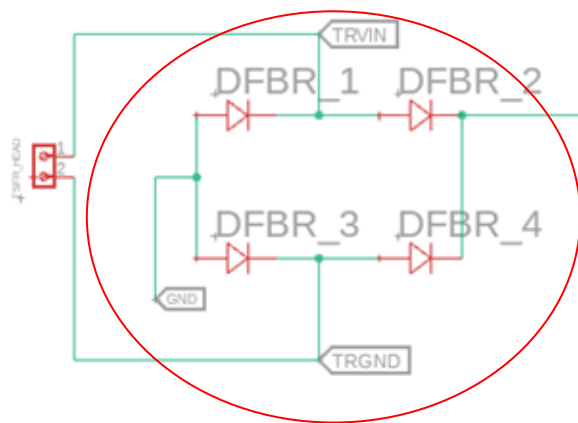
MCU Selection					
Metrics	ESP32	CC3235 MODx	Pico 2W	nRF52840x	STM32WB55
Processor	Dual Core 240 MHz	Single Core 80 MHz	Dual Core 133 MHz	Single Core 64 MHz	Dual Core 64 MHz + 32 MHz
UART	Yes				
RAM	520 KB SRAM	256 KB SRAM	520 KB SRAM	256 KB DRAM	256 KB SRAM
ADC	Yes - 12 bit				
Operating Voltage	3.3 V	3.3 V	5 V	5 V	1.6 V - 3.6 V
Power Consumption	0.528 Wh	0.736 Wh	0.297 Wh	0.0158 Wh	0.029 Wh
Cost Dev. Board	\$8.00	\$71.00	\$7.00	\$49.00	\$45.00
Cost Individual Module	\$7.00	\$26.00	\$7.00	\$49.00	\$45.00



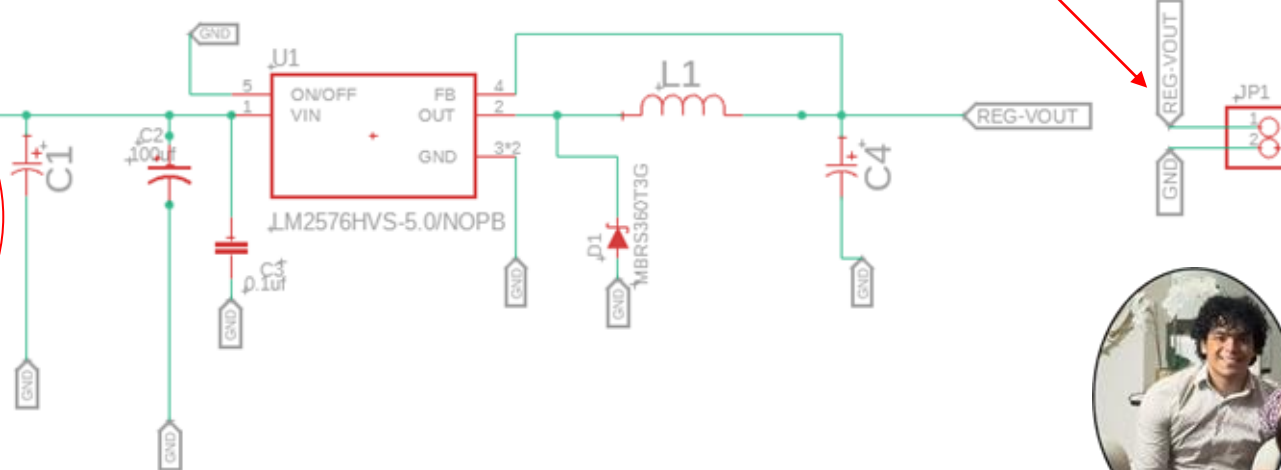
2nd PCB Board



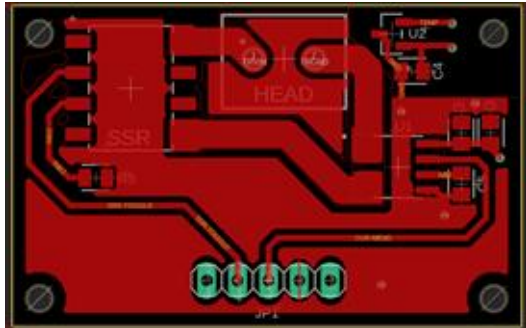
Full-Wave Rectifier



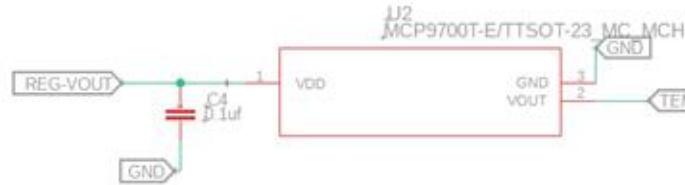
Step-Down Regulator



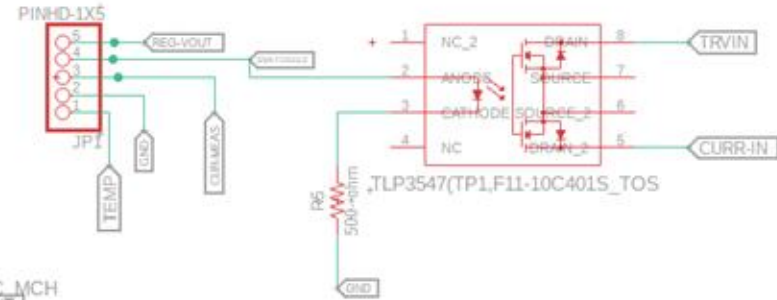
3rd PCB Board



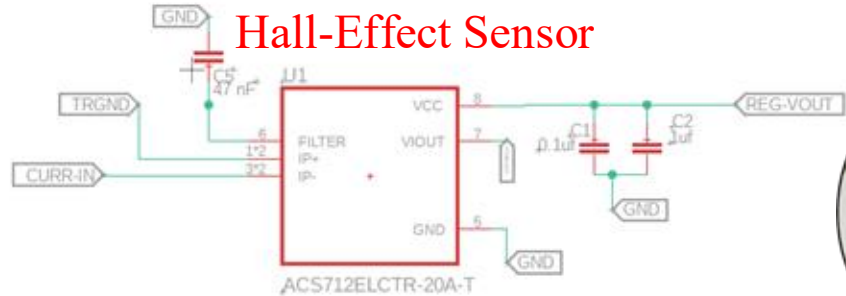
Temperature Sensor



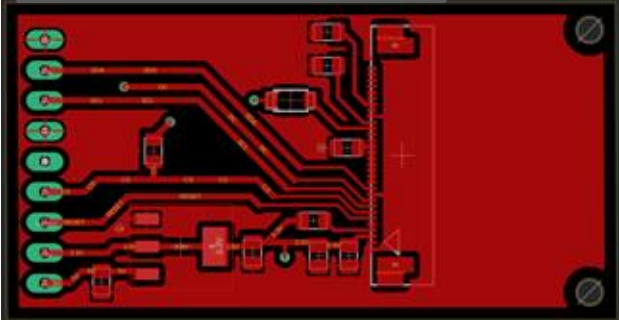
Solid-State Relay



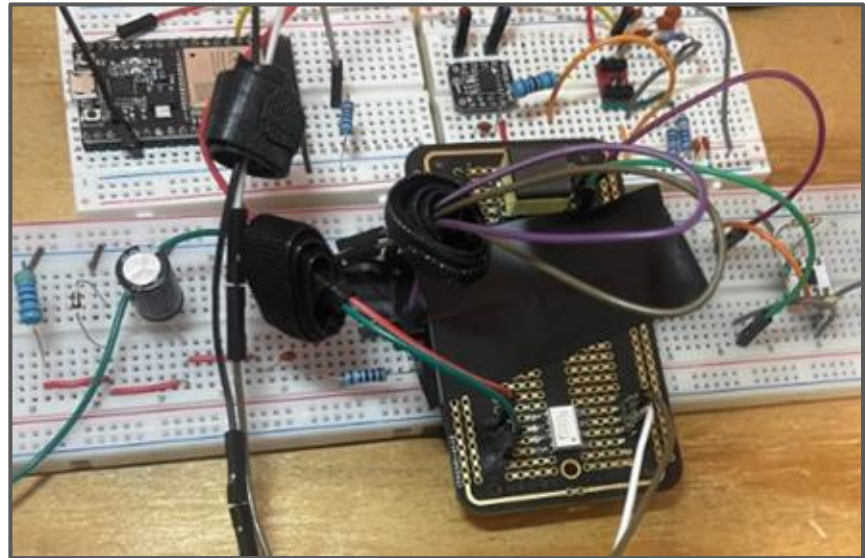
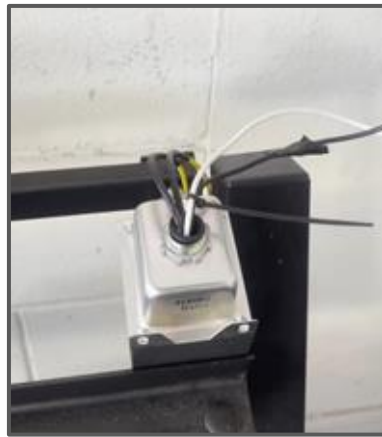
Hall-Effect Sensor



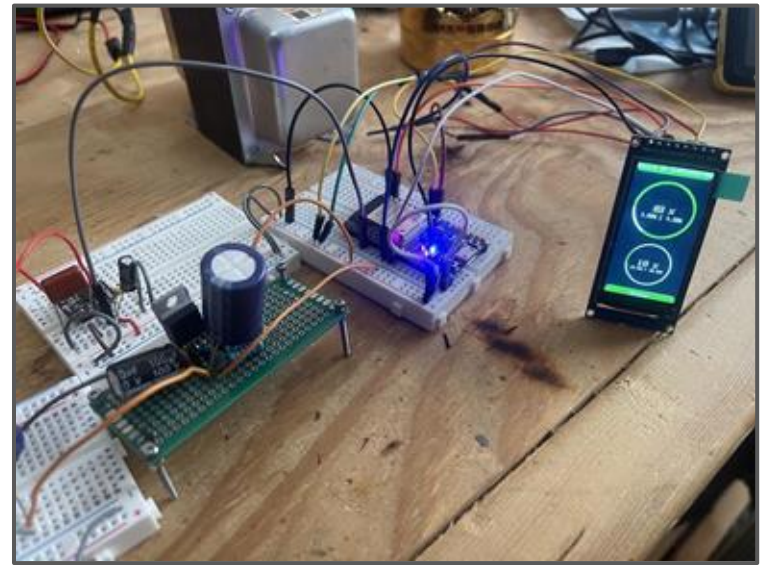
4th PCB
Board



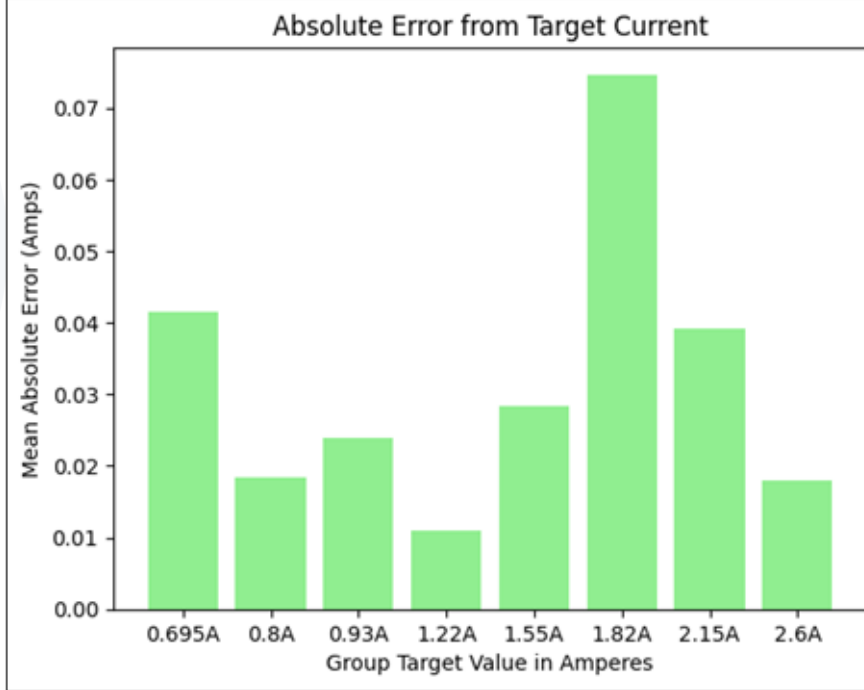
Prototyping



Prototyping Testing



Testing



Average Absolute Error for a sample selection w/ known Amperage.

Based on these preliminary assessments, we found the average deviation from the known target current to be about ~50mA.

Estimated Turn-Off time from the moment a sampling window begins to the SSR actually flipping off is at worst case roughly 17.7ms. Average roughly 8.2ms.

Based on current configuration of taking 100 samples along a single cycle at 6 KHz + worst case SSR turn off time of 1.0ms.



Embedding Programming Comparison



Programming Language Comparison			
Metrics	C/C++	MicroPython	Rust
Library Ecosystem	Large: Many existing libraries covering needs	Large: Many existing libraries covering needs. Not as large as C/C++	Moderate: Library support is growing, but not as vast compared to other options.
Speed	Fast: Compiled Language	Slow: Interpreted Language	Fast: Compiled Language
Ease-of-Use	Easy: Standard Development Process	Very Easy: Fast Development Process	Hard: Steep Learning Curve

Software Development Framework		
Metrics	Arduino Core	ESP-IDF
Ease-of-Use	Very Easy	Moderate
Performance	Good	Maximum
Abstraction	Primarily higher level abstraction	Full access to low level hardware
Library Support	Massive library ecosystem	Large, but pales in comparison to Arduino Core

Full Stack Comparison



Category	Our choice	Alternative	Reason
Frontend	React	Angular/Vue	React's massive ecosystem and virtual DOM are more efficient for high-frequency dashboard updates.
Backend	Node.js	Python	Node's non-blocking event loop is better at handling thousand of concurrent IoT socket connections. In addition Node offers extensive library support and packet management.
Database	MongoDB	PostgreSQL	NoSQL is more flexible for varying sensor data and is better for high volume logging.
Comm. Protocol w/ MCU	WebSockets	HTTP Polling	WebSockets reduce overhead by keeping one connection open, whereas HTTP a new handshake for every sensor update

Programming Language

Frontend: React with TypeScript — provides type safety, component reusability, and a responsive UI for the dashboard, settings, and authentication pages

Backend/Firmware: C/C++ via Arduino framework on the ESP32 MCU — handles real-time sensor polling, fault detection logic, SSR control, and Wi-Fi communication.

Backend Server: Node.js & Express — A high-performance middleware layer that exposes RESTful endpoints for the ESP32 to post sensor data and provides a WebSocket server for pushing real-time updates to the React dashboard.

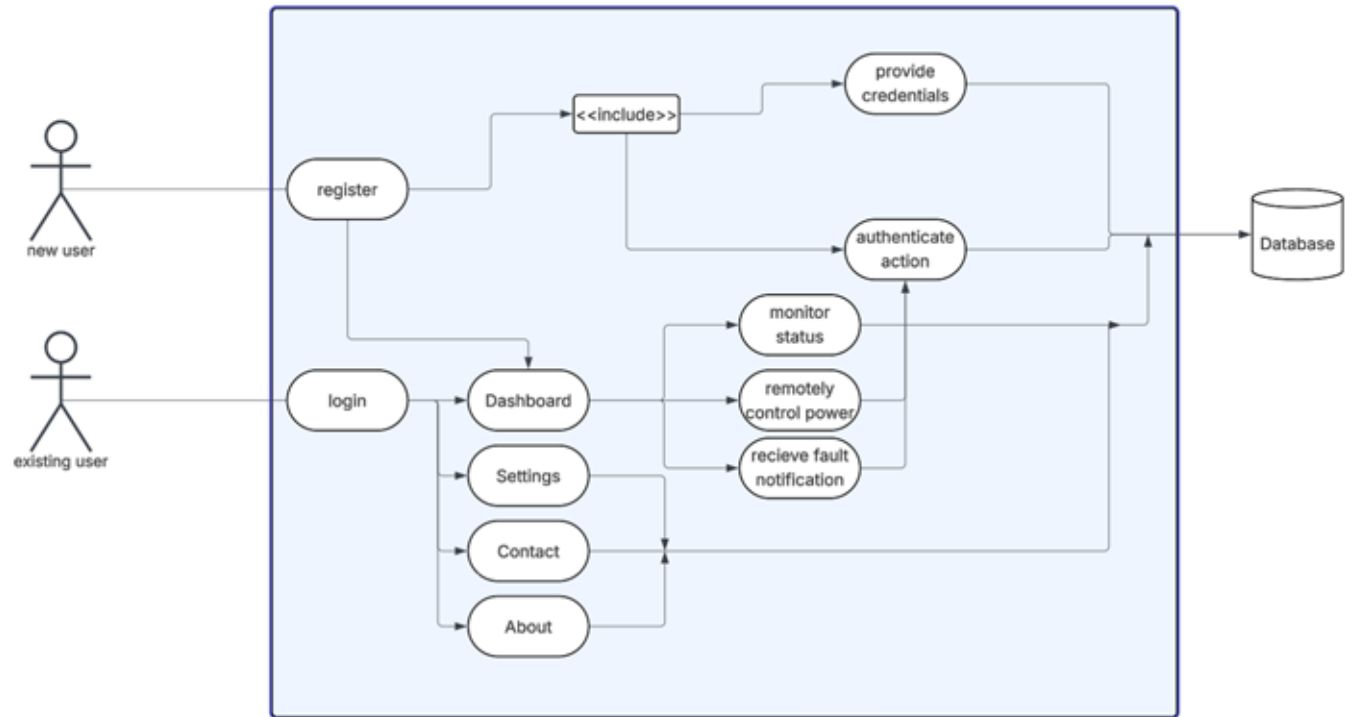
Database: MongoDB — NoSQL document database used by the Node.js backend to store persistent sensor logs, device configurations, and user profiles.

Communication Protocol(s): REST API — Used for standard CRUD operations and interaction with the database. (Login, Authentication, etc.)

Websockets — the MCU posts sensor data (current, temperature) to individual websocket connections based on matching deviceId and userID. Allows for full-duplex communication w/ minimal overhead relative to standard REST API.



Use Case Diagram



Website Interface



S.A.B.R.E. Home Dashboard Settings 

First Name *

Last Name *

Email *

Password *

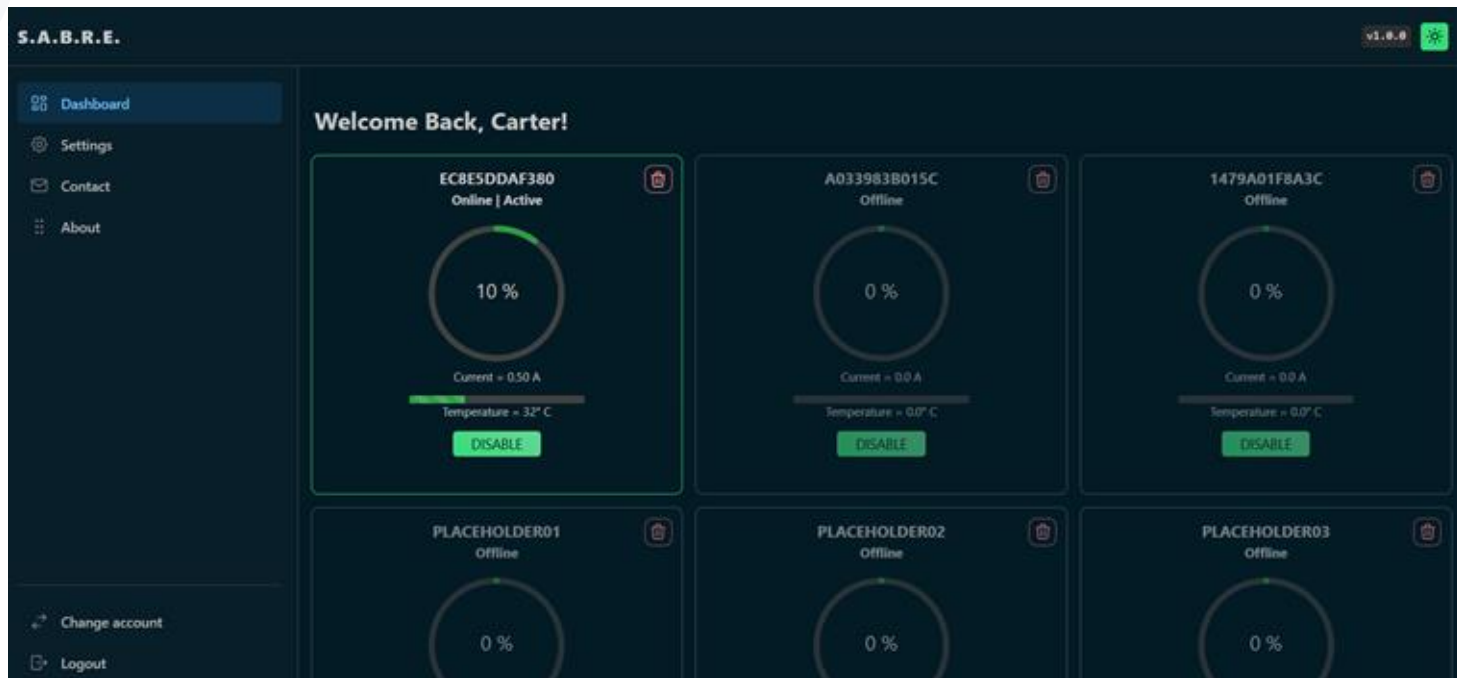


Register

Back to Login



Website Interface



Work distribution

Work Distribution	
Name	Responsibilities
Emmanuel Lopez	Administrative Content
	PCB Design
	Schematics Design
	PCB Soldering
Carter Harman	PCB Design
	Embedded Design
	Website backend
	PCB Soldering
David Durosini	Website Frontend
	Embedded Design
	PCB Soldering
	Website Communication
Eliezer Urdaneta	Project Lead
	Design Documentation
	Research Documentation
	PCB Manufacturing



Budget

Bill of Materials for PCB			
Component	Name	Qty	Cost
Flyback Regulator	LM5180NGUR	5	\$22.65
Replacement Buck Reg.	LM2576HV	3	\$26.40
30-Pin LCD Connector	WM7976CT-ND	2	\$5.42
60 mA LED DRV	AL5809-60P1-7	2	\$1.44
3.3 Linear Reg.	LD1117S33TR	5	\$1.70
30V Schottky Diode	BAT760-7	3	\$1.41
ESP32	ESP32-WROOM	2	\$9.68
UART Bridge	CP2102N	3	\$12.96
Hall Sensor 1	ACS71230A	2	\$5.84
Hall Sensor 2	ACS71220A	2	\$5.84
Screw Terminal	691137710002	5	\$1.80
Temperature Sensor	MCP9700T-E/TT	5	\$2.00
60V Schottky Diode	MBRS360T3G	4	\$1.28
FT LCD Display	ER-TFT019-1	2	\$12.78
Solid State Relay	TLP3547	3	\$22.98
SOT23 TO DIP ADAPTE	1568-00717-ND	2	\$2.50
LCD Breakout Boards	SPI TFT LCD Display Module	2	\$15.99
USBA Female Header	MEETOOT	10	\$6.99
Wirewound Potentiomete	Electronics-Salon 200W 500 OHM	1	\$35.00
100VA Transformer	TR100VA001	1	\$54.99
Micro Current Transform	DL-CT08CL5	2	\$7.99
Generic Perfboard Kit		32	\$8.50
Misc.	Resistors, Capacitors, Inductors		\$82.44
PCB Boards		5	\$41.61
PCB Shipping		5	\$84.01
Total			\$474.20



Progress



Action/Item	Status
Prototype Design	Complete
Prototype Testing	Complete
Implementation of Design in PCB	Complete
PCB Ordered	Complete
Testing of PCB Design	Mostly Completed
Chassis Design and Fabrication	In Progress
PCB Revision	
Website Design	In Progress
Software Design	Mostly Completed

Future Plans



Future Goals	Expected Completion Date	Duration
PCB soldered and finished initial testing phase	2/27/2026	2 Weeks
PCB Revised and ordered	2/27/2026	2 Weeks
Revised PCB Expected Arrival	03/10/2026	1.5 Weeks
Revised PCB Soldered and tested	3/20/2026	1 Week
Chasis Finished	3/21/2026	1 Month
Web Interface Finished	3/21/2026	1 Month
Final Allowable Revision Completed	04/07/2025	1 Week
D-Day	04/20/2026	



Questions?